## WHAT IS CLAIMED IS:

- 1. A pellicle for lithography which has at least, a pellicle film for dustproof protection, a pellicle frame to which the pellicle film is adhered, an adhesive layer provided on one end face of the pellicle frame in order to adhere the pellicle film, and a sticking layer formed on another end face of the pellicle frame, wherein the pellicle film is formed by a die coating machine.
- 2. The pellicle for lithography according to Claim 1 wherein an area of the pellicle film is 1000 cm<sup>2</sup> or more, and a distribution of a thickness of the film in plane is within  $\pm$  10 %.
- 3. The pellicle for lithography according to Claim 1 which is used in a lithography process for manufacture of a liquid-crystal-display panel.
- 4. The pellicle for lithography according to Claim 2 which is used in a lithography process for manufacture of a liquid-crystal-display panel.
- 5. A method for producing a pellicle film comprising at least a process of dissolving a raw material of a pellicle film in a solvent to prepare an application liquid, a process of coating a substrate with the application liquid, and a process of drying the substrate

to which the application liquid is applied, wherein the coating process is carried out with a die coating machine.

6. The method for producing a pellicle film according to Claim 5 wherein the coating process performed with the die coating machine is carried out in an amount of an application liquid in the range obtained from the following formula (1).

 $0.9 \times V1 < V < 1.1 \times V1$  (1)

 $(V1 = S \times t/(D/100))$ 

V(m3): an amount of an application liquid

S (m2): an area of a substrate

t(m): a film thickness after drying

D (%): a concentration of application liquid

- 7. The method for producing a pellicle film according to Claim 5 wherein the drying process comprises air-dry for 5 minutes or more in the air of which a flow rate on the surface of the substrate is 30 cm or less per second followed by drying at a temperature more than the boiling point of the application liquid.
- 8. The method for producing a pellicle film according to Claim 6 wherein the drying process comprises air-dry for 5 minutes or more in the air of which a flow rate on the surface of the substrate is 30 cm or less per second followed by drying at a temperature more than the boiling

point of the application liquid.

- 9. The method for producing a pellicle film according to Claim 5 wherein a pellicle film having an area of 1000 cm<sup>2</sup> or more is produced.
- 10. The method for producing a pellicle film according to Claim 6 wherein a pellicle film having an area of 1000 cm<sup>2</sup> or more is produced.
- 11. The method for producing a pellicle film according to Claim 7 wherein a pellicle film having an area of 1000 cm<sup>2</sup> or more is produced.
- 12. The method for producing a pellicle film according to Claim 8 wherein a pellicle film having an area of 1000 cm<sup>2</sup> or more is produced.
- 13. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 5 with the adhesive layer to one end face of the pellicle frame.
- 14. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film

produced by the method according to Claim 6 with the adhesive layer to one end face of the pellicle frame.

- 15. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 7 with the adhesive layer to one end face of the pellicle frame.
- 16. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 8 with the adhesive layer to one end face of the pellicle frame.
- 17. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 9 with the adhesive layer to one end face of the pellicle frame.
- 18. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 10 with the adhesive layer to one end face of the pellicle frame.

- 19. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 11 with the adhesive layer to one end face of the pellicle frame.
- 20. A method for producing a pellicle for lithography comprising at least providing an adhesive layer on one end face of a pellicle frame, and adhering the pellicle film produced by the method according to Claim 12 with the adhesive layer to one end face of the pellicle frame.
- 21. The pellicle for lithography produced by the method according to Claim 5.